

Product End-of-Life Disassembly Instructions

Product Category: Servers

Marketing Name / Model

[List multiple models if applicable.]

HPE ProLiant ML30 Gen9

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HPE products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

Item Description	Notes	Quantity of items included in product
Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)	With a surface greater than 10 sq cm	5
Batteries	All types including standard alkaline and lithium coin or button style batteries	2
Mercury-containing components	For example, mercury in lamps, display backlights, scanner lamps, switches, batteries	0
Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm	Includes background illuminated displays with gas discharge lamps	0
Cathode Ray Tubes (CRT)		0
Capacitors / condensers (Containing PCB/PCT)		0
Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height	Depending on Power Supply Model	5
External electrical cables and cords		0
Gas Discharge Lamps		0
Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above)		0
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner	Include the cartridges, print heads, tubes, vent chambers, and service stations. No	0
Components and waste containing asbestos		0
Components, parts and materials containing refractory ceramic fibers		0

Item Description	Notes	Quantity of items included in product
Components, parts and materials containing radioactive substances		0

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

Tool Description	Tool Size (if applicable)
Torx Driver	T-15
Philips screwdriver	#2
flat head screw driver or Long Nose Plier	

3.0 Product Disassembly Process

3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. System Board Battery - Remove the side panel and remove the battery from the system board
2. Capacitors in 350W power supply => 2.5 cm - Remove the power supply bracket from the system with a T-15 torx driver, and to remove the PSU from PSU bracket with a T-15 torx driver. With a #2 Philips screw driver remove the screws securing the top cover then locate the capacitors and pry from the PCB with a flat head screw driver or Long Nose Plier and dispose off properly
3. Capacitors in 460W power supply => 2.5 cm - Remove the power supply bracket from the system with a T-15 torx driver, and to remove the PSU from PSU bracket with a T-15 torx driver. With a #2 Philips screw driver remove the screws securing the top cover then locate the capacitors and pry from the PCB with a flat head screw driver or Long Nose Plier and dispose off properly
- 4.
- 5.

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

Attachment 1 – Remove MB and System battery

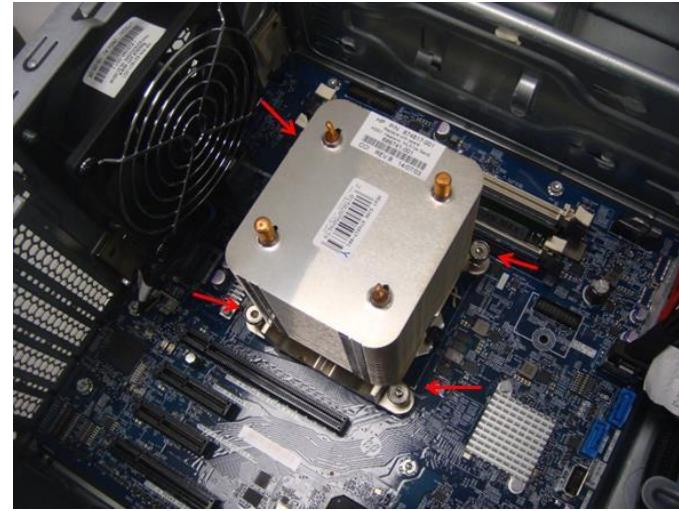
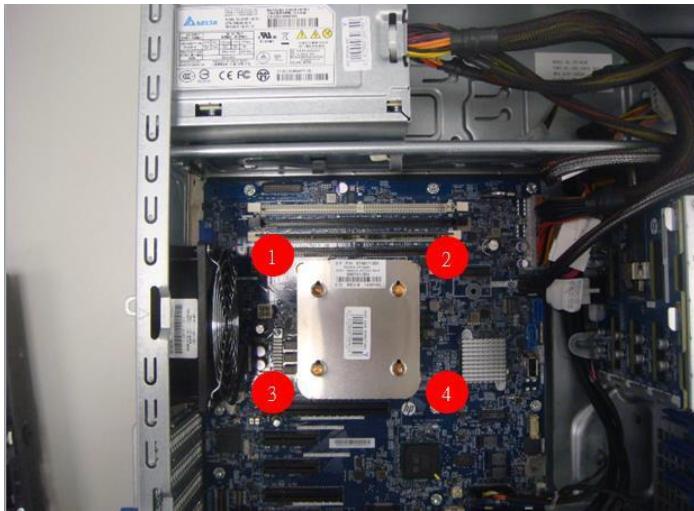
Attachment 2 – Remove the Megacell

Attachment 3 – 350W Power Supply Capacitor Location

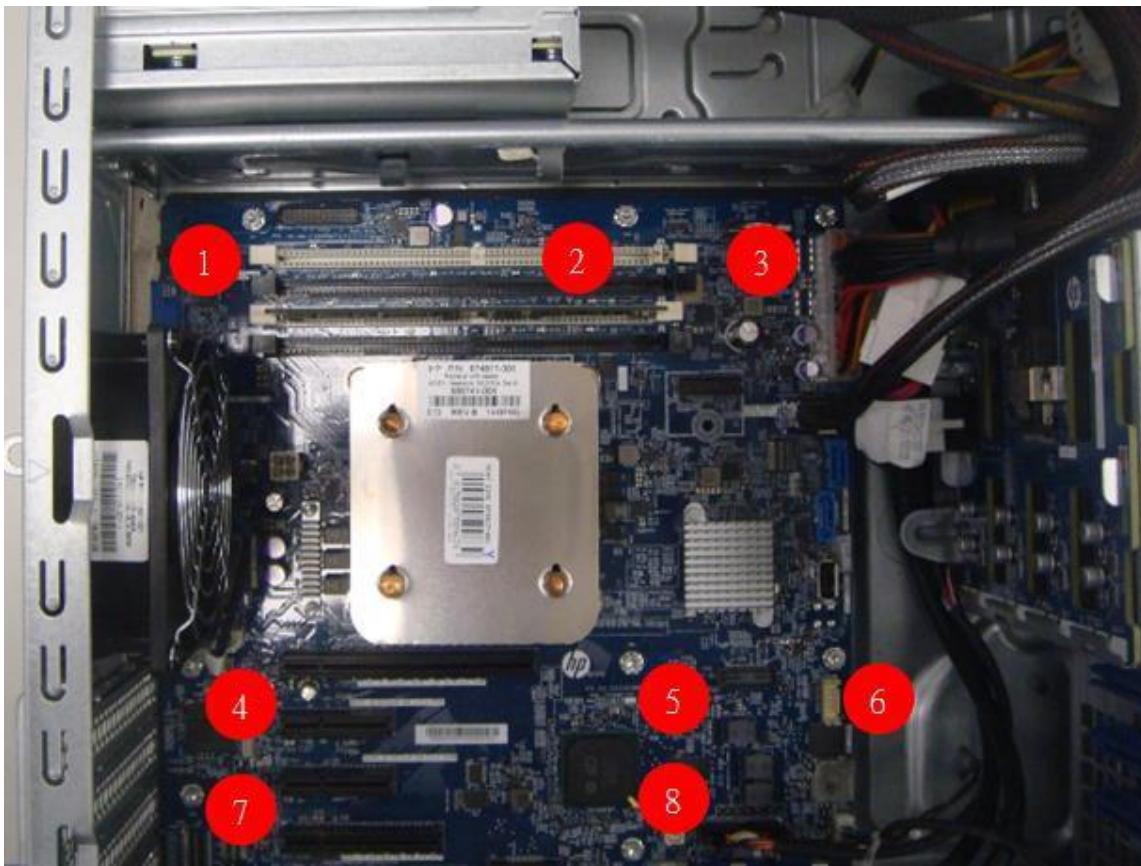
Attachment 4 – 460W Power Supply Capacitor Location

Attachment 1 –Remove MB and System battery

1. Remove HS screws as NO.1~4 shown.



2. Remove MB screws as NO.1~8 shown.

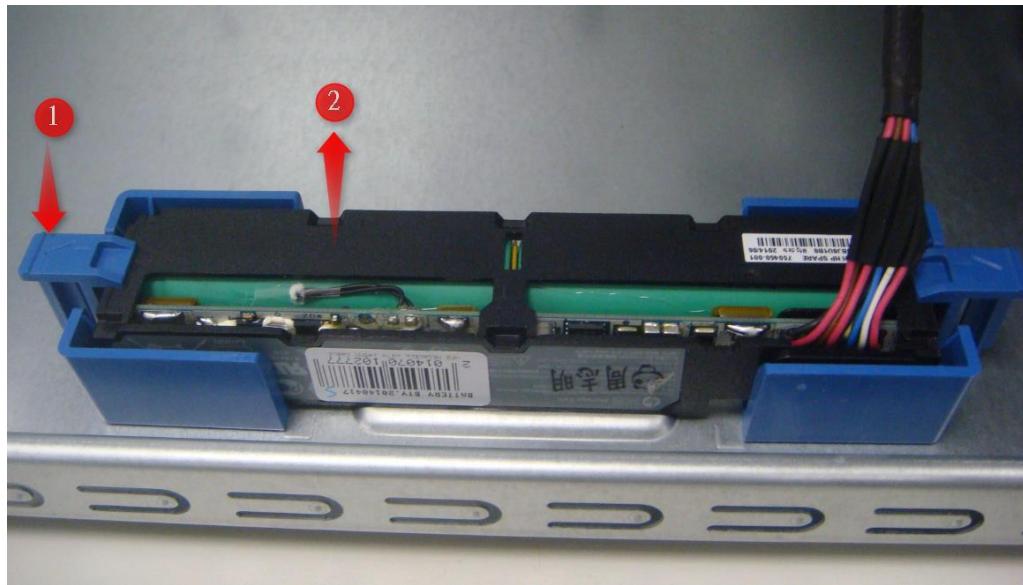


3. Take off the system battery.



Attachment 2 –Remove the Megacell

1. Push the latch (No.1) and remove Megacell (No.2).



Attachment 3 – 350W Power Supply Capacitor Location

a) ES 1.0 350W power supply capacitor location



b) ES 2.0 350W power supply capacitor location



Attachment 4 – 460W Power Supply Capacitor Location

a) Lite-on HSTNS-PL14



b) Emerson HSTNS-PR17



c) Delta DPS-460EB

